

# Part 2 Optoelectronic Components

## ♦ Optical components and product families

- Active optical components
  - Light sources : light emitting diodes and laser diodes
  - Detectors and optical receivers
  - Optical amplifiers
  - Components for the optical routing



#### Passive optical components

- The FBG technology
- Components realized using the FBG technology
- The AWG technology and associated components
- Optical connectors

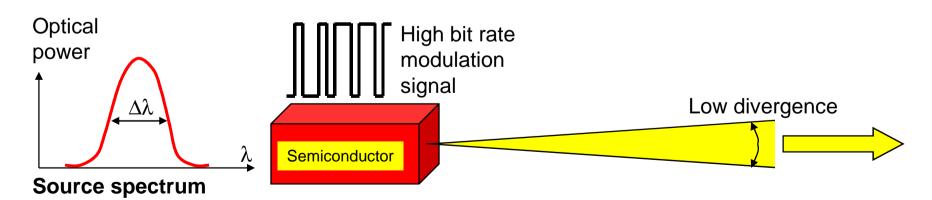






# **Light sources (1)**

- Main characteristics required
  - Semiconductor source (compact and easy to implement)
  - High emitted optical power
  - Low divergence beam for better coupling efficiency to fiber
  - Narrow spectral width for reducing chromatic dispersion and for dense WDM application
  - Possibility of high bit rate modulation







# **Light sources (2)**

- ♦ Two possible candidates
  - LED (light emitting diode)
  - LD (laser diode)
- ♦ The light emitting diode (LED) : not performant enough



- Low emitted power (some tens microwatts μW)
- Too high beam divergence thus bad coupling efficiency to fiber
- Broad spectral width (some tens nm)
- The laser diode (LD): the best appropriate source
  - High emitted power (some tens milliwatts mW)
  - Very low beam divergence (high coupling efficiency to a singlemode fiber)
  - Very narrow spectral width, well matched to WDM systems







# Light sources (3)

- ♦ The optical power of a source
  - Explained either in milliwatts (mW), or in dBm (dB reported to 1mW)
  - Power (dBm) = 10 log Power (mW)

Power in mW	Power in dBm
1 mW 2 mW 4 mW 10 mW 100 mW Multiply by 2 Divide by 2 Multiply by 10 Divide by 10	0 dBm + 3 dBm + 6 dBm + 10 dBm + 20 dBm Add 3 dBm Substract 3 dBm Add 10 dBm Substract 10 dBm

### **Examples:**

+ 23 dBm

= +20 dBm +3 dBm

 $= 100 \times 2 = 200 \text{ mW}$ 

- 26 dBm

= -20 dBm - 6 dBm

 $= 1/100 \times 1/4 \text{ mW}$ 

 $= 0.01 \times 0.25 \text{ mW}$ 

= 0.0025 mW

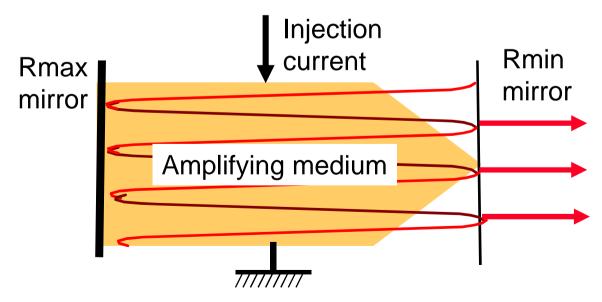
 $= 2.5 \mu W$ 

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# Laser diodes (1)

- ◆ LASER = Light Amplification by Stimulated Emission of Radiation
- Laser = amplifying medium in a resonant cavity (Fabry-Perot)
- Semiconductor laser (or laser diode)
  - Amplifying medium : diode type junction
  - Pumping technique : injection current
  - Resonant cavity: cleaved facets of the laser chip

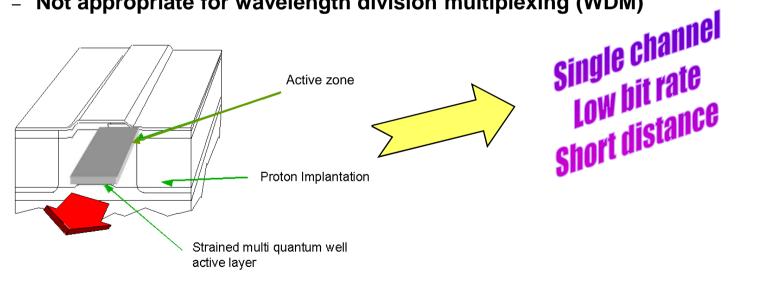


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# Laser diodes (2)

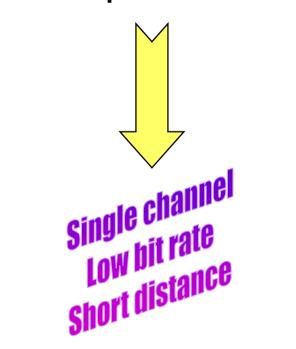
- Two categories of laser diodes (1)
  - FP: Fabry-Perot type laser diode
    - The most simple structure
    - Broad spectrum (multiple rays) => limitation due to chromatic dispersion
    - Used for short distance links
    - Not appropriate for wavelength division multiplexing (WDM)





# Laser diodes (3)

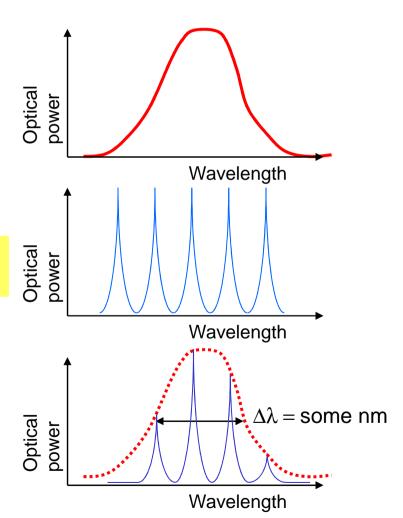
Fabry-Perot laser diode spectrum



Active material gain curve

Fabry-Perot cavity spectrum (comb)

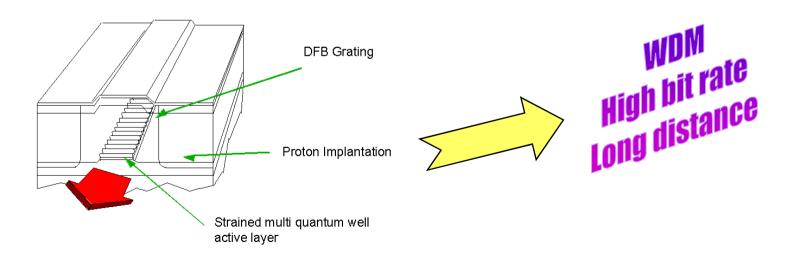
Fabry-Perot laser diode spectrum





# Laser diodes (4)

- ♦ Two categories of laser diodes (2)
  - DFB: Distributed Feed-Back laser diode
    - More complex structure (integrated diffraction grating)
    - Narrow spectrum (single longitudinal mode) ==> very low chromatic dispersion
    - Well suited to long haul links and to WDM systems



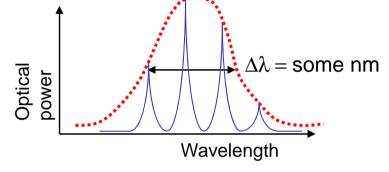


# Laser diodes (5)

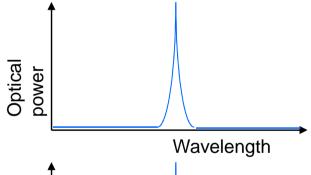
DFB laser diode spectrum



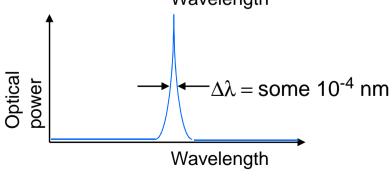
Fabry-Perot laser diode spectrum



Diffraction grating filtering



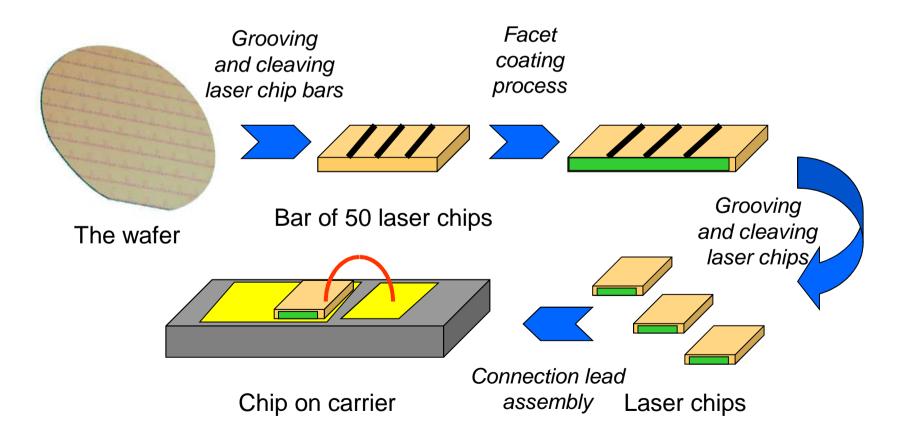
DFB laser diode spectrum





# Laser diodes manufacturing

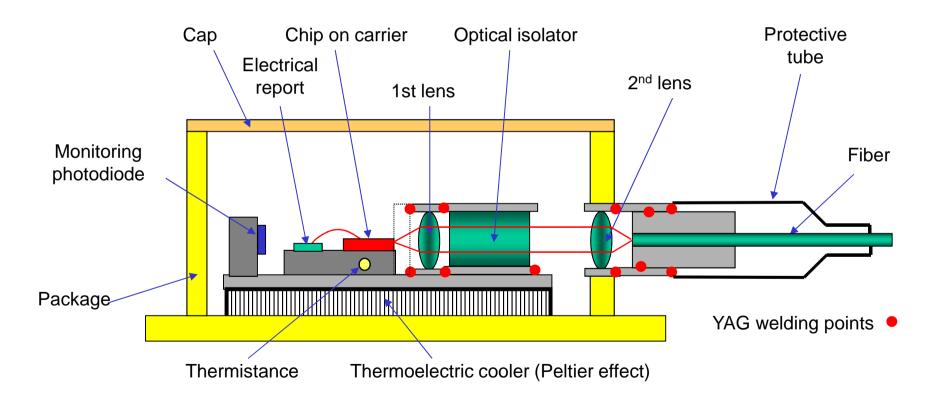
From the wafer to the chip-on-carrier (COC)





# Laser diodes packaging

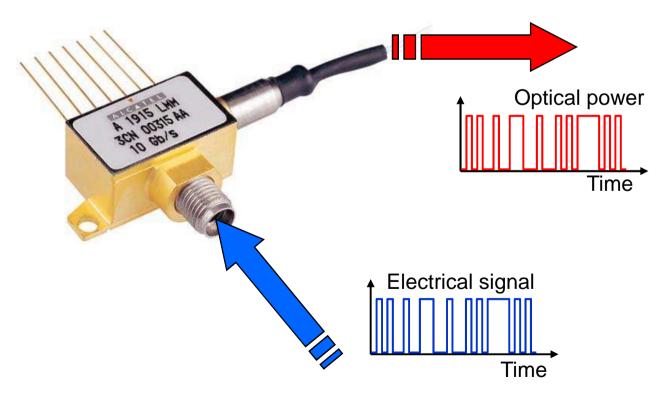
### ♦ Packaging of a transmitter module with an optical isolator





# Laser diode modulation

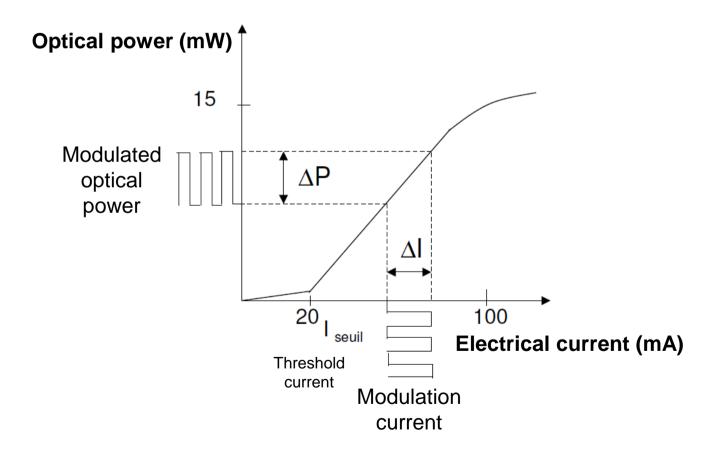
- Modulating an optical source
  - Transforming the electrical signal variation into an optical power variation





## Transfer characteristics of a laser diode

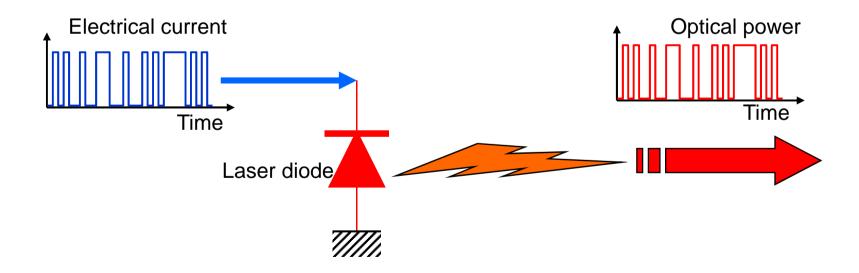
♦ Optical power vs electrical current characteristics of a laser diode





## Direct modulation of a laser diode

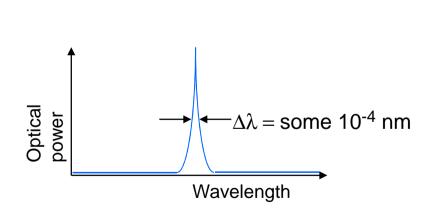
- ◆ Direct modulation (1)
  - The laser diode is directly modulated by an electrical current (injection current)



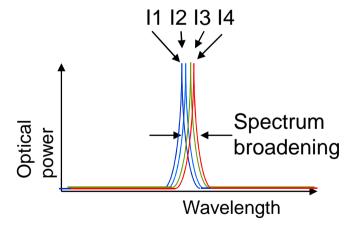


### Direct modulation of a laser diode

- Direct modulation (2)
  - Main problem inherent to direct modulation : the chirp
  - It is the optical frequency variation due to injection current modulation
  - The chirp induces laser diode spectrum broadening, which limits transmission distance due to a higher chromatic dispersion of the fiber



Constant modulating current = CW spectrum => No chirp

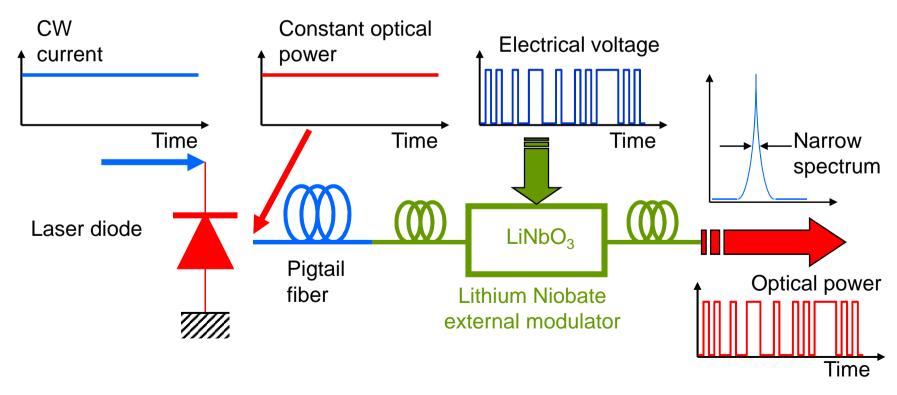


Direct modulation = current variation Spectrum broadening due to chirp



#### External modulation of a laser diode

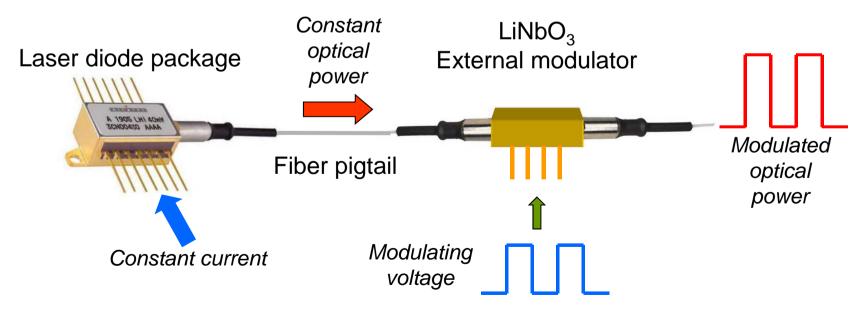
- ♦ External modulation (1)
  - Modulation method to avoid laser diode chirp
  - Allows to significantly increase transmission distance





#### External modulation of a laser diode

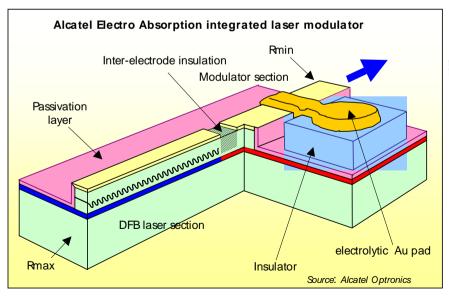
- External modulation (2)
  - Two technologies of external modulation
    - 1. Use of an external modulator device separated from the laser diode (as Lithium Niobate modulator)
      - The laser diode is not directly modulated and provides a constant optical power entering the external modulator





#### External modulation of a laser diode

- **♦** External modulation (3)
  - Monolithic integration technology
    - 2. Monolithic integration of the laser diode and the external modulator on the same substrate
      - The external modulator is usually an Electro-Absorption (EA) modulator
      - Its absorption coefficient is depending on the modulation voltage
      - This kind of modulator shows a low chirp limiting transmission distance







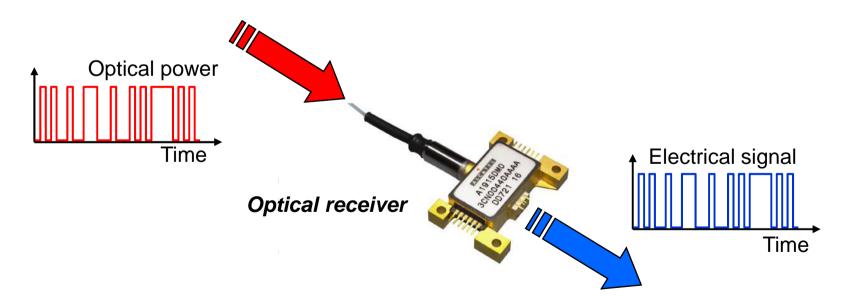
# Comparison of laser diode modulations

- Comparison of the three technologies
  - Direct modulation by the injection current :
    - Used for bit rates up to 2.5 Gbit/s
    - Maximum transmission distance : 90 km (1800 ps/nm source)
  - External modulation with separated laser diode and LiNbO<sub>3</sub> external modulator:
    - Use for very high bit rates up to 40 Gbit/s
    - Almost illimited transmission distance (transoceanic systems)
  - Integrated laser-modulator (ILM):
    - Used for medium bit rates (2.5 Gbit/s or 10 Gbit/s)
    - Transmission distance limited by the proper chirp of the EA modulator
      - ◆ At 2.5 Gbit/s: from 360 km (7200 ps/nm) to 640 km (12800 ps/nm)
      - ◆ At 10 Gbit/s: from 40 km (800 ps/nm) to 80 km (1600 ps/nm)



# Detectors and optical receivers

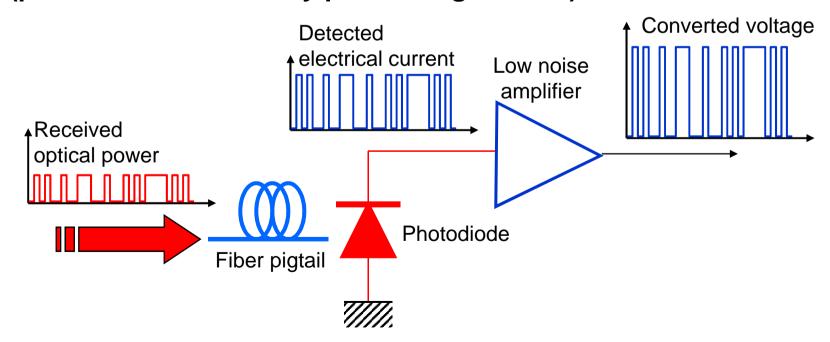
- The optical receiver transforms the modulated optical power detected into a modulated electrical signal
- It consists of an optical detector (photodiode) followed by electrical circuits processing the detected signal





# **Optical detectors: photodiodes**

- A photodiode transforms the optical power received into an electrical current (photocurrent)
- ♦ This signal is electrically amplified (low noise amplifier) and then processed. This function is realized by the optical receiver (photodiode followed by processing circuits)





# Types of photodiodes

#### **♦** Two main types of photodiodes

- PIN photodiode (Positive-Intrinsic-Negative)
  - Simple structure easy to implement
  - Used for very high bit rates (up to 40 Gbit/s)

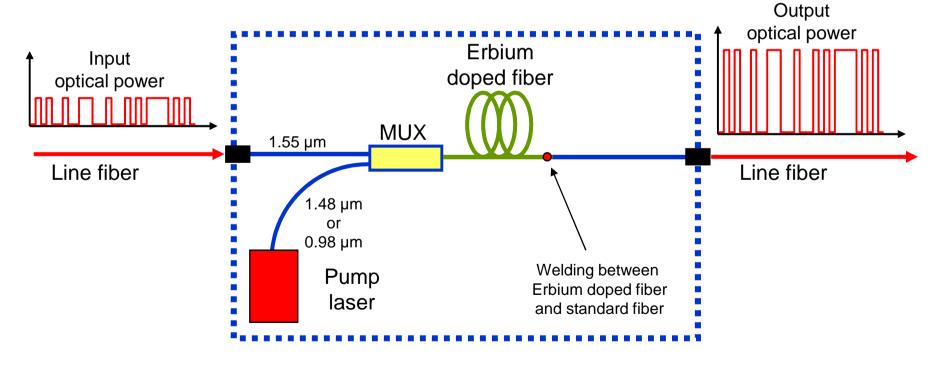
#### Avalanche photodiode (APD)

- More complex structure
- Requires a high driving voltage
- Allows to generate a higher detected current
- Better sensitivity for detecting low levels of received optical power (long distance systems)
- Used for bit rates up to around 10 Gbit/s



# **Optical Fiber Amplifiers (OFA)**

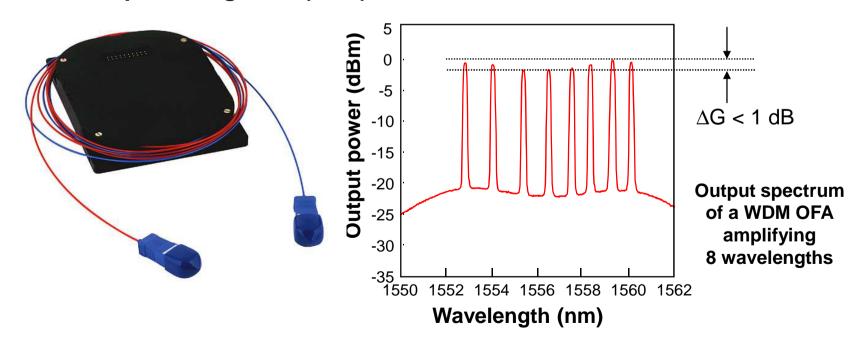
- Principle of the Erbium doped fiber amplifier (EDFA)
- ◆ Direct amplification of the optical power by energy transfer from pump wave to signal wave





## **OFAs for WDM application**

- **♦** Specific characteristics of WDM OFAs
  - Requires a good flatness of gain spectrum
  - Need for a double stage structure with mid-stage access for adddrop multiplexing (ADM) application or for inserting a dispersion compensating fiber (DCF)





## Components for optical routing

- These components will be used in node equipments of future all optical networks
  - Optical routing requires basic functions as :
    - Optical switching (non-blocking switching matrices)
    - Wavelength conversion
  - These functions can be realized using the following technologies :
    - Semiconductor optical amplifier (SOA) for fast switching
    - Interferometric wavelength converter module (ICM) for wavelength conversion







## Semiconductor optical amplifier

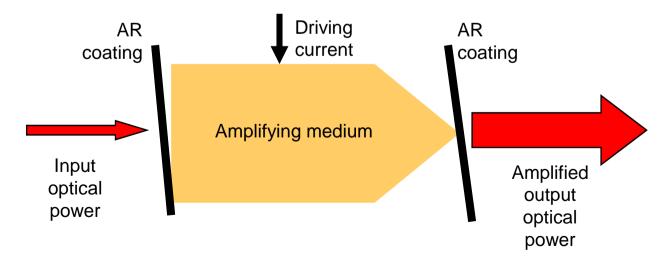
# **♦** SOA = Semiconductor Optical Amplifier

#### Structure

- Similar structure as for the semiconductor laser diode
- Suppression of the resonant FP cavity through anti-reflection coating and angled cleaving the two facets of the chip

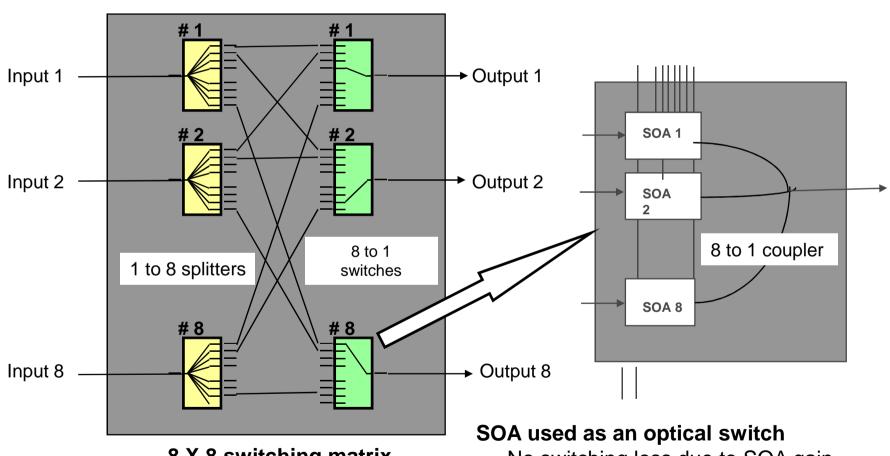
#### Quaternary amplifying medium : InGaAsP

For amplification in the 1.55 μm range





# **Optical switching using SOA bars**



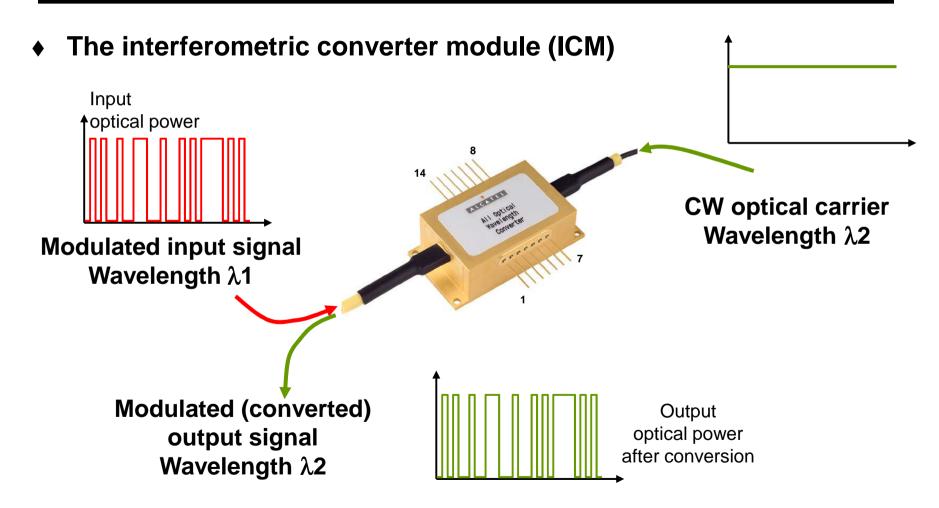
**8 X 8 switching matrix**Possible extension up to 64 x 64

- No switching loss due to SOA gain

- High speed switching time (some 10 ps)



# **Wavelength conversion**





# Components for very high bit rate applications

- Components dedicated to future 40 Gbit/s applications
  - SDH standard : STM-256 frame
  - SONET standard : OC-768 frame
- ♦ Electroabsorption (EA) modulator
- ♦ Integrated PIN-preamp receiver
- ♦ In the near future : integrated laser-modulator (ILM) source

EA modulator for 40 Gbit/s applications





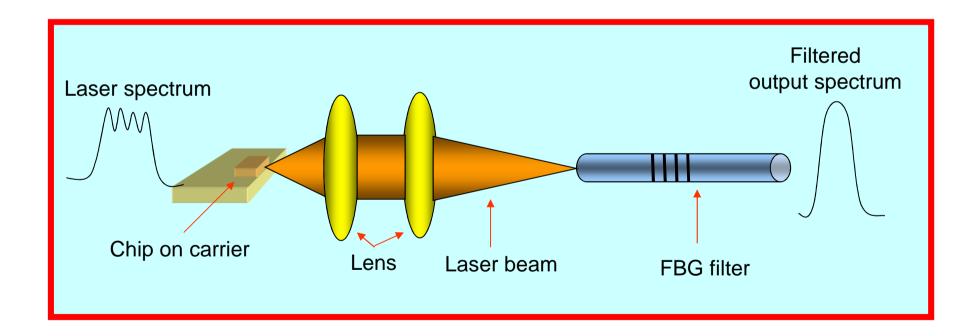
# Passive components (1)

- Passive components do not require any electrical energy for working
- ♦ Two specific technologies allow to realize passive components :
  - FBG (Fiber Bragg Grating) technology
    - Bragg grating made in a silica fiber
    - Used to realize compact optical filters
      - Gain flattening filters for OFAs
      - Wavelength stabilizing filters for pump lasers
      - Band-pass filters for WDM application
  - AWG (Arrayed Waveguide Grating) technology
    - Waveguide gratings made in silica-on-silicon platforms
    - Used for realizing wavelength MUX and DEMUX



# Passive components (2)

♦ Example of use of a FBG filter as a band-pass filter





## Passive components (3)

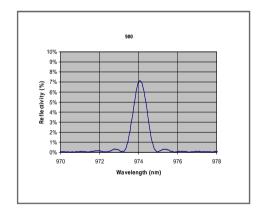
#### Mux/Demux

- ♦ Arrayed Waveguide Grating
- Silica on silicon based
- ◆ 16x100GHz, 40x50GHz or 40x100GHz channels
- ♦ Low input to output loss



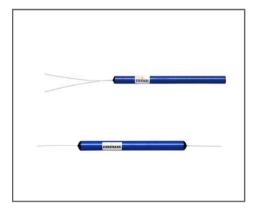
#### Pump stabilizer

- ♦ FBG technology
- 1480 nm or 980 nm pump



#### Wavelength filters

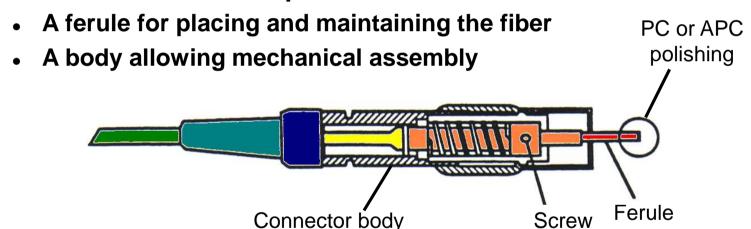
- ♦ FBG technology
- ♦ Band-pass filters
- ♦ ADM filters
- Gain flattening filters





## **Optical connectors (1)**

- **♦** An optical connector is used for a non-permanent assembly
- It consists in two main parts:



- ♦ Two types of ferules
  - Defined by the quality of the optical polished surface :
    - PC (Physical Contact): hemispheric polishing
    - APC (Angled-PC): angled (around 7°) hemispheric polishing



## **Optical connectors (2)**

#### Main types of optical connectors

- FC (field connector) with screw and positioning key: the most common
- SC (subscriber connector) : push-pull type with plastic body
- ST (standard connector): with positioning key
- E2000 : European connector with plastic body
- MU : push-pull type miniature connector
- LC (low cost): small connector with plastic body

#### Main characteristics

- Insertion loss (or assembly loss): < 0.5 dB</li>
- Return loss (or reflection loss): < -50 dB (PC), < -60 dB (APC)</li>



# Main types of optical connectors

